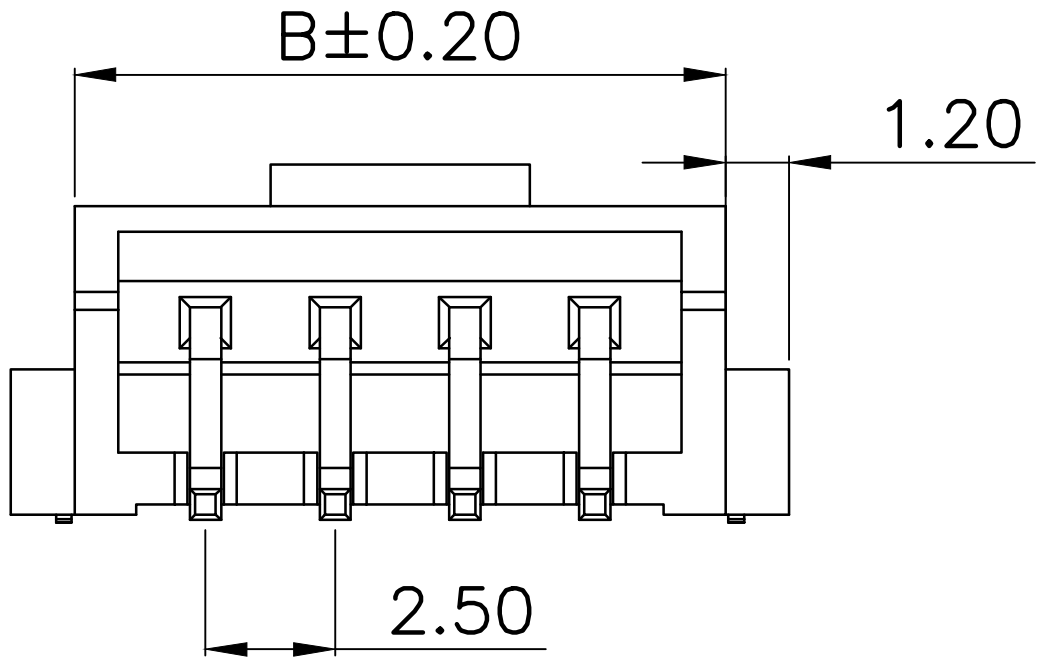
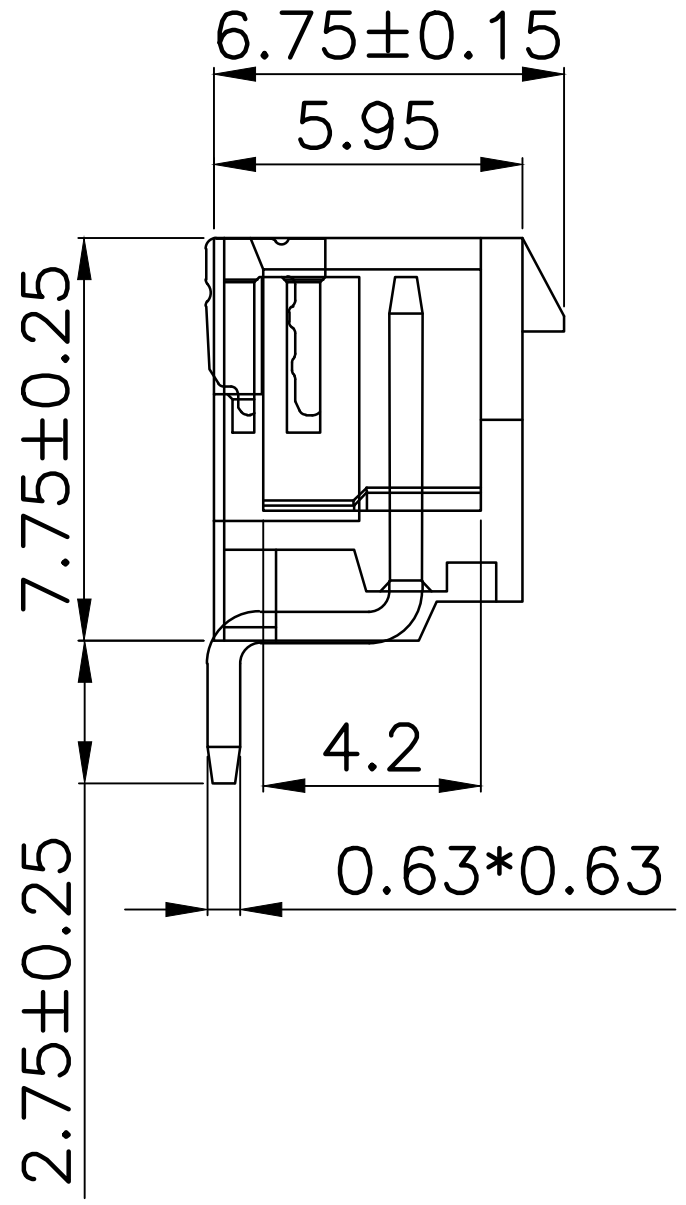
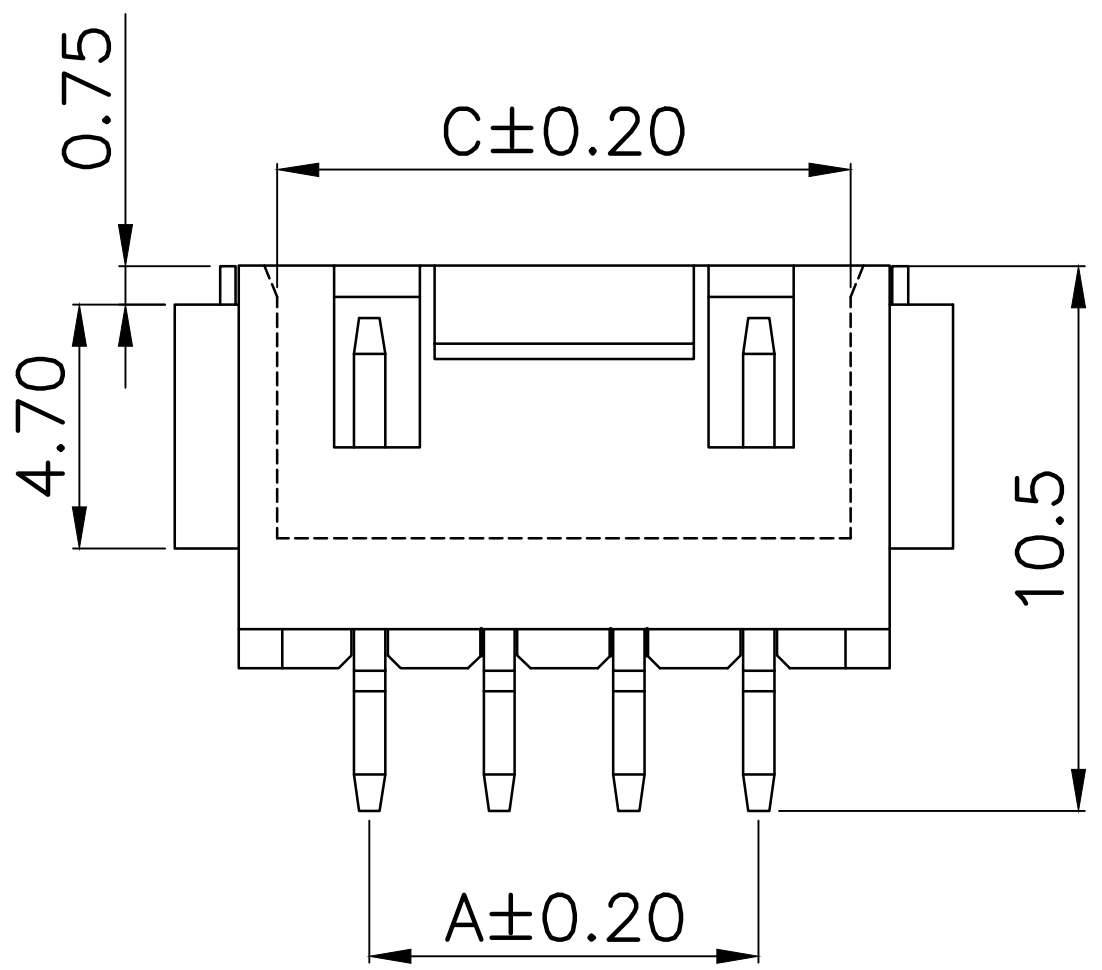
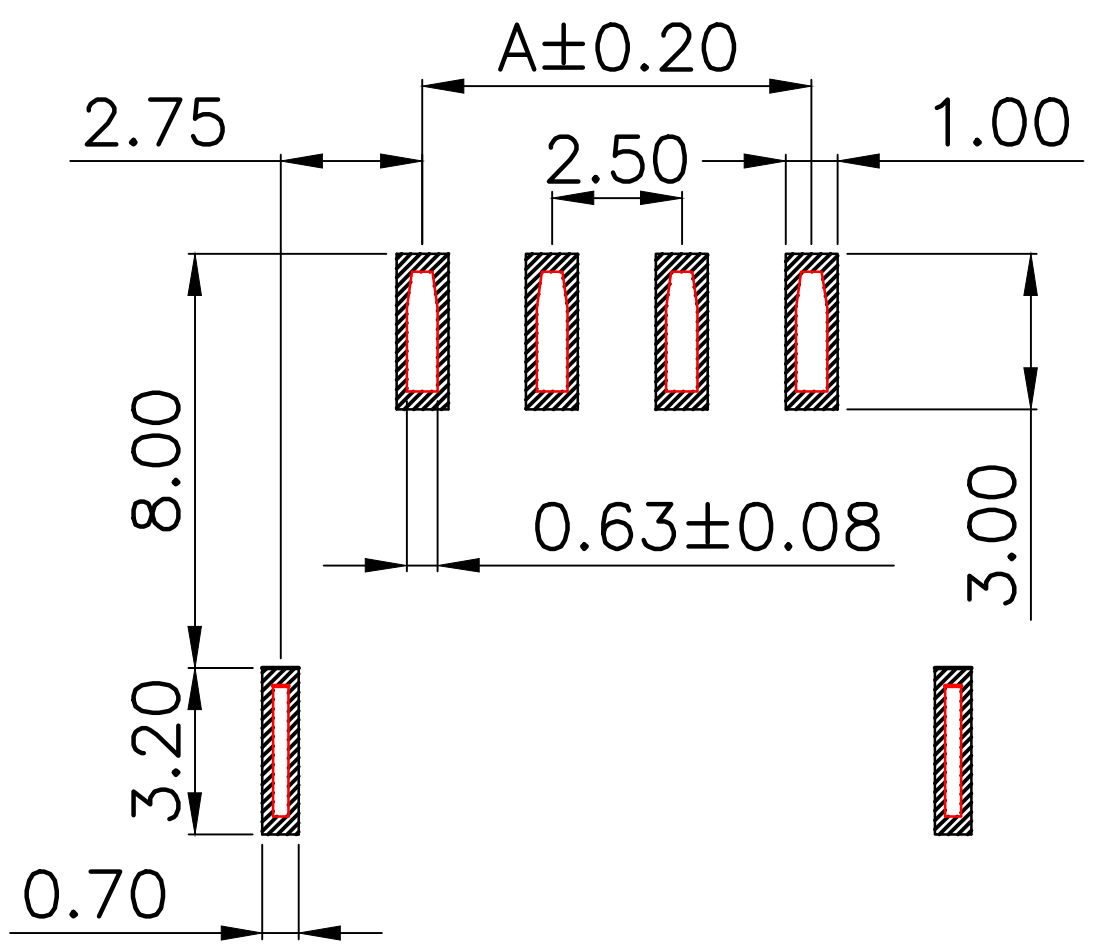
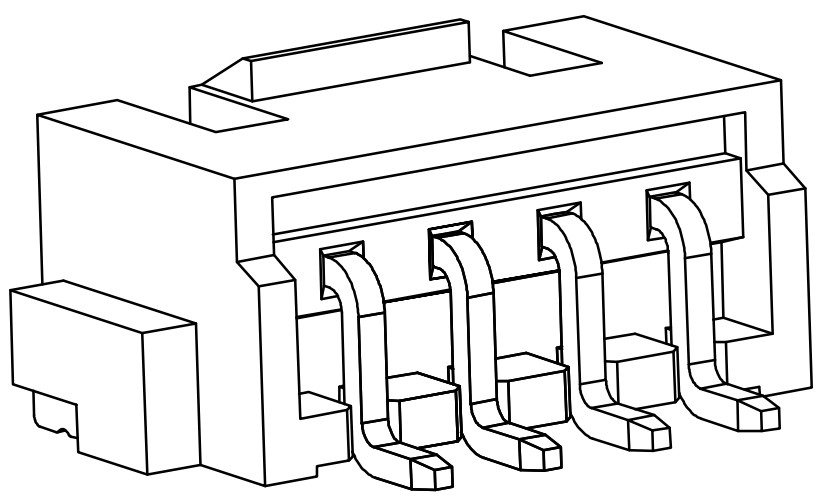








适用线路板(PCB LAYOUT)



Model No.	Pin	A	B	C
WAFER-XHB2.54-2PWT	2	2.50	7.50	6.05
WAFER-XHB2.54-3PWT	3	5.00	10.00	8.55
WAFER-XHB2.54-4PWT	4	7.50	12.50	11.05
WAFER-XHB2.54-5PWT	5	10.00	15.00	13.55
WAFER-XHB2.54-6PWT	6	12.50	17.50	16.05
WAFER-XHB2.54-7PWT	7	15.00	20.00	18.55
WAFER-XHB2.54-8PWT	8	17.50	22.50	21.05
WAFER-XHB2.54-9PWT	9	20.00	25.00	23.55
WAFER-XHB2.54-10PWT	10	22.50	27.50	26.05
WAFER-XHB2.54-11PWT	11	25.00	30.00	28.55
WAFER-XHB2.54-12PWT	12	27.50	32.50	31.05
WAFER-XHB2.54-13PWT	13	30.00	35.00	33.55
WAFER-XHB2.54-14PWT	14	32.50	37.50	36.05
WAFER-XHB2.54-15PWT	15	35.00	40.00	38.55
WAFER-XHB2.54-16PWT	16	37.50	42.50	41.05
WAFER-XHB2.54-17PWT	17	40.00	45.00	43.55
WAFER-XHB2.54-18PWT	18	42.50	47.50	46.05
WAFER-XHB2.54-19PWT	19	45.00	50.00	48.55
WAFER-XHB2.54-20PWT	20	47.50	52.50	51.05

Specifications/技术规格:

1. Poles/线数：2～20P
2. Wire range/适用线规：AGW 28#～22#
3. Applicable PC board thickness/适用PC板厚度：1.6mm
4. Current rating/额定电流：3.0A
5. Voltage rating/额定电压：250V DC/AC
6. Insulation Resistance/绝缘电阻：1000MΩ Min
7. Dielectric Withstanding/ 耐电压：1000V AC/minute
8. Contact Resistance/ 接触电阻：20mΩ Max
9. Operating Temperature/ 工作温度：-25℃ to +85℃

NO.	Name	Number	Qty	Materil	Remarks
Ⓒ	Soldering lug		1	Brass	Plating Sn
Ⓑ	Terminal			Brass	Plating Sn
Ⓐ	Housing		1	LCP	Off White

深圳市宝通成电子有限公司

angle	±2°	design		date		name	WAFER CONNECTOR
10~30	±0.30	Review		date			
5~10	±0.20	Approved		date		model	BTC-XHB2.5-N*P WT
~ 5	±0.10	Drawing number:					
Tolerance not specified		Proportion	1:1	unit	mm	gape number	A4

modify | Review | Approved